

## Power - Diode

Power diodes are also similar to signal diodes but have a little difference in its construction.

In signal diodes, the doping level of both P & N sides is same and hence we get a PN-Junction.

In power diodes, we have a junction formed between a heavily doped  $P^+$  & a lightly doped  $N^-$  layer.  $N^-$  layer is epitaxially grown on a heavily doped  $N^+$  layer.

The  $N^-$  layer is the key feature of the power diode which makes it suitable for high power applications. This layer is lightly doped, almost intrinsic & hence the device is known as PIN diode, where I stands for intrinsic.

## Applications of Power Diode -

(i) Battery charging

(ii) AC rectifiers

(iii) Inverters

(iv) Free wheeling diodes

(v) Frequency rectifier.

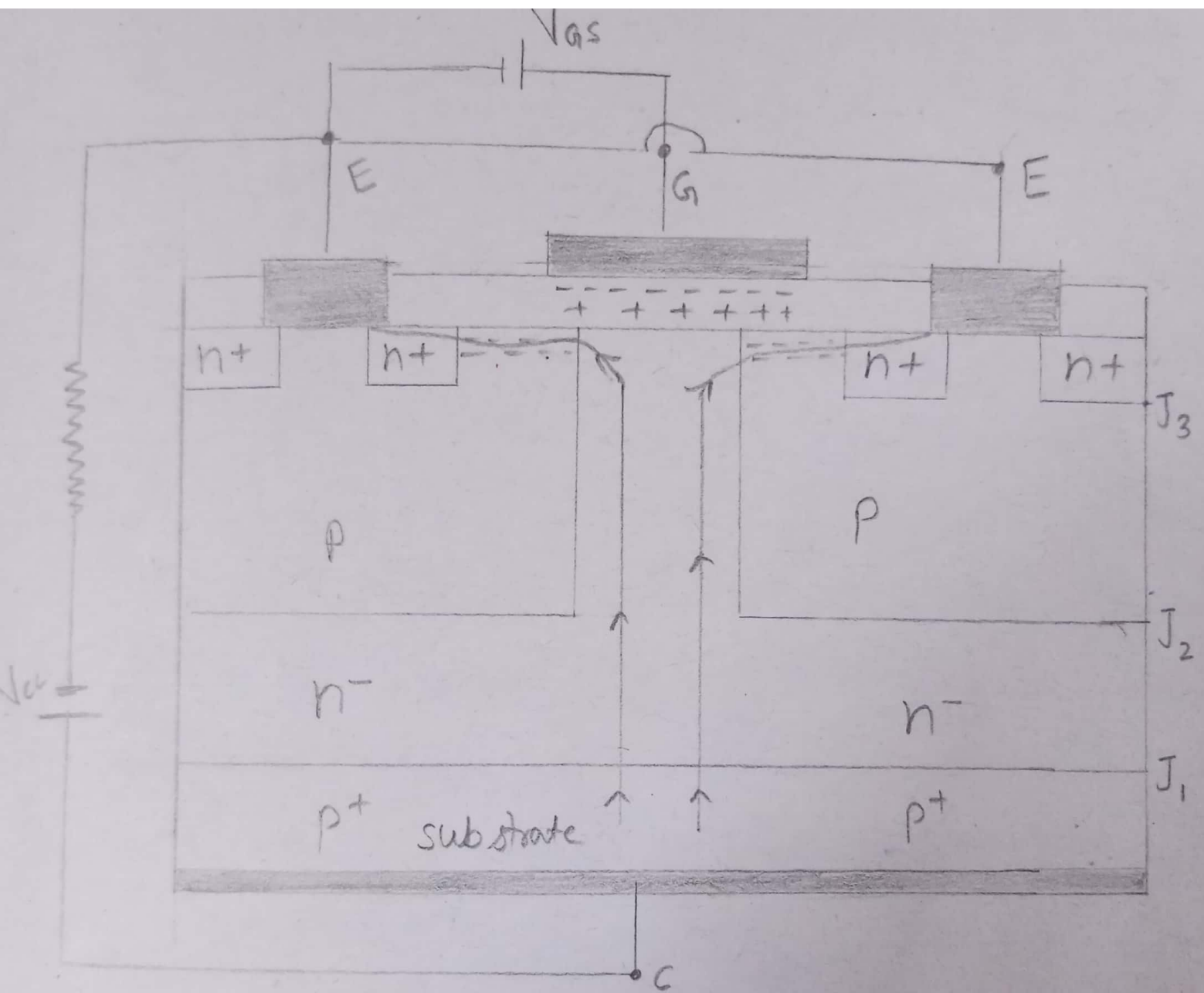
# IGBT

(Insulated Gate Bipolar Transistor)

IGBT is a voltage controlled power electronics device. It is a device which combines the fast acting features and high power capability of bipolar transistor with the voltage control features of MOSFET gate.

Construction -

It has three terminals collector, emitter & gate. The structure of IGBT is plain & similar to vertical power MOSFET, excluding  $P^+$  injecting layer.



## Working -

When collector is made positive w.r.t. emitter, IGBT gets forward bias. With no voltage between gate & emitter, two junctions between  $n^-$  &  $p^-$  region (i.e.,  $J_2$ ) are reverse bias, so no current flows from C to E.

When G is +ve w.r.t. E, with  $V_{GE}$  voltage, an n-channel or inversion layer is formed. This n-channel short-ckt. the  $n^-$  &  $n^+$  emitter region. Electrons begin to flow from  $n^+$  to  $n^-$  region through n-channel. As

As IGBT is in F.B.,  $p^+$  injects holes into  $n^-$  region. The  $h^+$  (injection carrier) density in  $n^-$  region increases & conductivity of  $n^-$  region enhances. Therefore IGBT gets turned on & begins to conduct forward current  $I_C$ .

$$I_C = I_E = I_h + I_e$$

## Symbol -

